

DEUTSCH

TE Internal #: ZPF00000000000545

Connector Contacts, Pin, Gold, Gold, 115 VAC, 115 VDC, Spring

Contact Retention, Size Size 20, Cable-to-Cable, Discrete Wire, 24 –

18 AWG Wire Size

View on TE.com >



Connectors > Rectangular Connectors > Connector Contacts



Contact Type: Pin

Contact Mating Area Plating Material: Gold

Wire Contact Termination Area Plating Material: Gold

Operating Voltage: 115 VDC

Features

Product Type Features

Barrel Type	Crimp
Connector System	Cable-to-Cable
Sealable	Yes
Connector & Contact Terminates To	Wire & Cable
Configuration Features	
Compatible With Wire & Cable Type	Discrete Wire
Electrical Characteristics	
Operating Voltage	115 VDC
Contact Features	
Contact Type	Pin
Contact Mating Area Plating Material	Gold
Wire Contact Termination Area Plating Material	Gold
Contact Retention Within Housing	With
Contact Size	Size 20
Contact Base Material	Copper Alloy
Contact Current Rating (Max)	7.5 A

Crimp

Termination Features

Termination Method to Wire & Cable



Mechanical Attachment

Contact Retention Type Within Housing	Spring
Dimensions	
Wire Size	.25 – 1 mm²
Usage Conditions	
Operating Temperature Range	-65 – 125 °C[-85 – 257 °F]
Operation/Application	
Circuit Application	Power, Signal & High Speed Data

Product Compliance

For compliance documentation, visit the product page on TE.com>

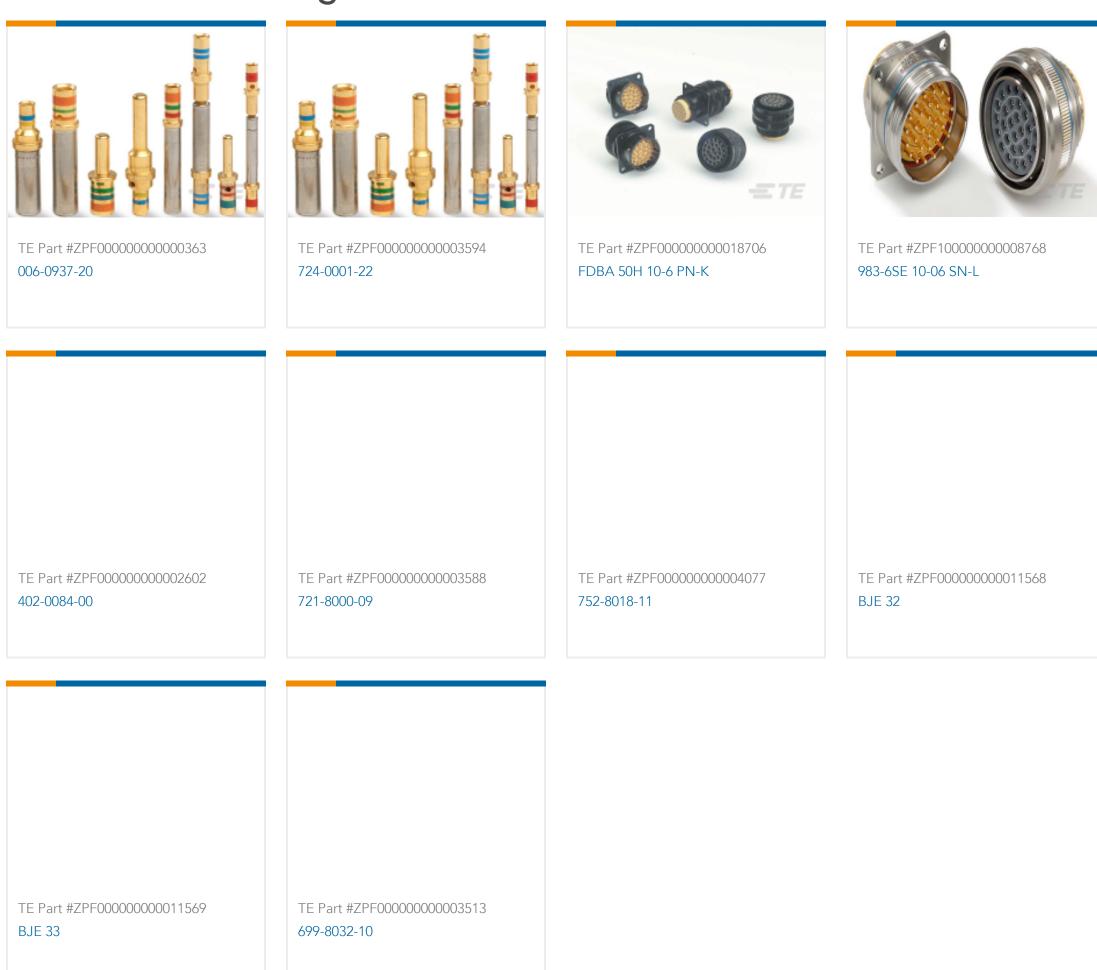
EU RoHS Directive 2011/65/EU	Compliant with Exemptions
EU ELV Directive 2000/53/EC	Out of Scope
China RoHS 2 Directive MIIT Order No 32, 2016	Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JAN 2022 (223) Candidate List Declared Against: JAN 2022 (223) SVHC > Threshold: Pb (1.2% in alloy) Article Safe Usage Statements: Do not eat, drink or smoke when using this product. Wash thoroughly after handling. Recycle if possible and dispose of the article by following all applicable governmental regulations relevant to your geographic location.
Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free
Solder Process Capability	Not reviewed for solder process capability

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach



Customers Also Bought



Documents

Datasheets & Catalog Pages

DEUTSCH Contacts Quick Reference Guide

English